

DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

Safety Certification: NPO/X7R (Pb Free & RoHS compliant) X1/Y2 AND X2/Y3 2.2 pF to 4.7 nF



YAGEO Phicomp



SCOPE

This specification describes safety certification NP0/X7R series chip capacitors with lead-free terminations.

<u>APPLICATIONS</u>

- PCs, Notebook
- Networking
- Power supplies
- Automotive

FEATURES

- Supplied in tape on reel
- Nickel-barrier end termination

ORDERING INFORMATION - 12NC & CLEAR TEXT CODE

Part numbers below are identified by the series, size, tolerance, packing style, TC material, rated voltage and capacitance value. Both 12NC or CTC code are acceptable to be used as Phycomp brand.

YAGEO BRAND ordering codes

CTC CODE

(1) (2) (3) (4) (5) (6) (7)

(1) SIZE - INCH BASED (METRIC)

1808 (4520)

1812 (4532)

(2) TOLERANCE

 $B = \pm 0.1 pF$

 $C = \pm 0.25 pF$

 $D = \pm 0.5pF$

 $F = \pm 1\%$

 $G = \pm 2\%$

 $1 = \pm 5\%$

 $K = \pm 10\%$

 $M = \pm 20\%$

(3) PACKING STYLE

K = Embossed Plastic Tape; Reel 7 inch

(4) TC MATERIAL

NP0

X7R

(5) SAFETY RATED VOLTAGE

T = X2/Y3 for TUV

W = XI/Y2 for TUV

U = X2/Y3 for UL

V = XI/Y2 for UL

(6) PROCESS

B = BME

N = Non BME

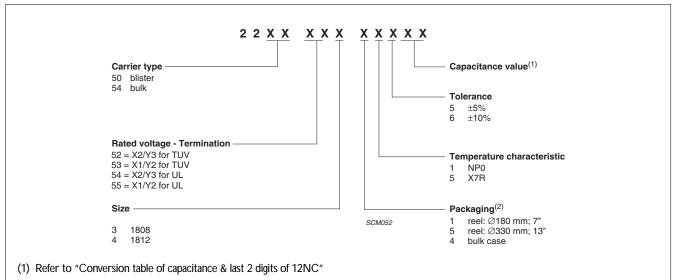
(7) CAPACITANCE VALUE

First two for significant figures and 3rd for number of zero. Letter "R" for decimal point



PHYCOMP BRAND ordering codes

12NC CODE



(2) Quantity on reel depends on thickness classification; see section "Thickness classification and packing quantities for safety certification MLCC

—Conversion table of capacitance & last 2 digits of 12NC

CAP. (pF)	Last 2 digits of 12NC												
2.2	18	12	24	33	29	82	35	220	41	560	46	1500	52
3.3	19	15	25	39	31	100	36	270	42	680	47	1800	53
4.7	21	18	26	47	32	120	37	330	43	820	48	2200	54
5	22	22	27	56	33	150	38	390	44	1000	49	3300	56
10	23	27	28	68	34	180	39	470	45	1200	51	4700	58

CTC CODE (FOR NORTH AMERICA ONLY)

● Example: 1808CG101JTBB1S

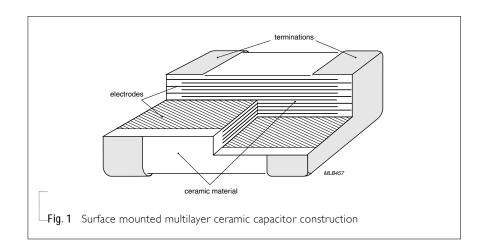
1808	CG	101	J	Т	В	В	. 1	S
Size code	Temp. Char.	Capacitance in pF	Tolerance	Safety rated voltage	Termination	Packing	Marking	Range identifier
	2R = X7R	11 11 1 1	$B = \pm 0.1 \text{ pF}$ $C = \pm 0.25 \text{ pF}$ $D = \pm 0.5 \text{ pF}$ $F = \pm 1\%$ $G = \pm 2\%$ $J = \pm 5\%$ $K = \pm 10\%$ $M = \pm 20\%$	T = X2/Y3 for TUV W = X1/Y2 for TUV U = X2/Y3 for UL V = X1/Y2 for UL	B = NiSn	B = 180 mm; 7" blister	I = marking 0= no marking	S = Safety certification



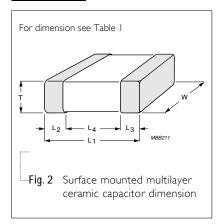
CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.



DIMENSION



lable 1						
TYPE		SC1808	SC1812			
L ₁ (mm)		4.5 ±0.30	4.5 ±0.30			
W (mm)		2.0 ±0.30	3.2 ±0.30			
T (mm)		Refer to table 2	Refer to table 2 to 4			
L ₂ /L ₃ (mm) min.		0.25	0.25			
L ₂ /L ₃ (mm) max.		0.75	0.75			
L ₄ (mm) min.	X1/Y2(TUV)	4.00	4.00			
	X2/Y2 (TUV)	2.20	2.20			
	UL	2.20	2.20			

CAPACITANCE RANGE & THICKNESS FOR NPO XI/Y2 AND X2/Y3

Table 2 For NP0 X1/Y2 and X2/Y3 sizes from 1808 to 1812

CAPACITANCE		1808, X1/Y2		1812, X1/Y2	1812, X2/Y3
(pF)	TUV	UL	TUV	UL	TUV
2.2					
3.3					
4.7					
5					
10					
12					
15					
18		1.6±0.2			
22			1.6±0.2	1.6±0.2	
27	1.6±0.2				
33					
39					
47					1.15±0.15
56					
68					
82					
100					
150					
180				2.0±0.2	
220		2.0±0.2			
270	2.0±0.2		2.0±0.2		
330					
390					
470					

NOTE

- 1. Values in shaded cells indicate thickness class in mm.
- 2. Capacitance range < 10 pF is on request.
- 3. Capacitance value of non E-12 series is on request.

CAPACITANCE RANGE & THICKNESS FOR X7R XI/Y2 AND X2/Y3

Table 3 For X7R X1/Y2 and X2/Y3 sizes from 1808 to 1812

CAPACITANCE		1808, X1/Y2		1808, X2/Y3		1812, X1/Y2	1812, X2/Y3
(PF)	TUV	UL	TUV	UL	TUV	UL	TUV
150							
180	1.6±0.2	1.6±0.2					
220							
270					1.6±0.2	1.6±0.2	
330							
390							
470							
560	2.0±0.2	2.0±0.2					
680						2.0±0.2	
820			1.35±0.15		2.0±0.2	2,0±0,∠	
1,000							
1,200				2.0±0.2			
1,500				2,0±0,2			
1,800							1.35±0.15
2,200							
3,300							
4,700							

NOTE

- 1. Values in shaded cells indicate thickness class in mm.
- 2. Capacitance value of non E-12 series is on request.

THICKNESS CLASSES AND PACKING QUANTITY

SIZE	THICKNESS CLASSIFICATION	12 mm TAPE WIDTH /AMOUNT PER REEL
CODE	(mm)	Ø180 mm, 7" Blister
1808	1.15 ±0.15	1,500
	1.35 ±0.15	1,000
<u> </u>	1.6 ±0.20	2,000
	2.0 ±0.20	2,000
1812	1.15 ±0.15	1,500
_	1.35 ±0.15	1,000
	1.6 ±0.20	1,000
	2.0 ±0.20	2,000
	1808	CODE (mm) 1808 1.15 ±0.15 1.35 ±0.15 1.6 ±0.20 2.0 ±0.20 1812 1.15 ±0.15 1.35 ±0.15 1.6 ±0.20



ELECTRICAL CHARACTERISTICS

NP0/X7R DIELECTRIC CAPACITORS; NISN TERMINATIONS

Unless otherwise stated all electrical values apply at an ambient temperature of 20±1 °C, an atmospheric pressure of 86 to 106 kPa, and a relative humidity of 63 to 67%.

 Га	h	Р	F

DESCRIPTION	VALUE
Capacitance range (1)	2.2 pF to 4.7 nF
Capacitance tolerance (1)	±5% and ±10%
Dissipation factor (D.F.) (1)	
NP0	≤ 0.1%
X7R	≤ 2.5%
Insulation resistance after 1 minute at U _r (DC)	$R_{ins} \ge 10 \text{ G}\Omega \text{ or } R_{ins} \times C \ge 500 \text{ seconds whichever is less}$
Maximum capacitance change as a function of temperature	
(temperature characteristic/coefficient):	±30 pom/°C
NP0	±30 ppm/°C
X7R	±15%
Operating temperature range:	
NP0/X7R	–55 °C to +125 °C
Climatic category (EN 122400)	NP0: 55/125/21
Climatic category (EN 132400)	X7R: 55/125/56

NOTE

SOLDERING RECOMMENDATION

 Ia	b	le	6

SOLDERING METHOD	SIZE 0402	0603	0805	1206	≥ 1210
Reflow	≥ 0.1µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	



^{1.} NP0: frequency = 1 MHz for C ≤ 1 nF, measuring at voltage 1 V_{rms}; frequency = 1 KHz for C > 1 nF, measuring at voltage 1 V_{rms} X7R: frequency = 1 KHz for C \leq 10 μ F, measuring at voltage 1 V_{rms}

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Surface-Mount Ceramic Multilayer Capacitors | Safety Certification | X1/Y2 & X2/Y3

YAGEO Phicomp Surface-Mount Ceramic Multilayer Capacitors | Safety Certification | NP0/X7R | X1/Y2 & X2/Y3

—Table 7 Test condition, procedure and requirements (conti
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TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
Bond strength of plating on	IEC 60384- 4.8 21/22		Mounting in accordance with IEC 60384-22 paragraph 4.3	No visible damage
end face			Conditions: bending I mm at a rate of I mm/s, radius jig 340 mm	NP0: $ \Delta C/C $: $\leq 1\%$ or 0.5 pF whichever is greater X7R: $ \Delta C/C $: $\leq 10\%$
Resistance to soldering heat		4.9	Precondition: 150 +0/−10 °C for I hour, then keep for 24 ±1 hours at room temperature Preheating: for size ≤ 1206: 120 to 150 °C for I minute Preheating: for size >1206: 100 to 120 °C for I minute and 170 to 200 °C for I minute Solder bath temperature: 260 ±5 °C Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours.	The termination shall be well tinned NP0: $ \Delta C/C $: $\leq 0.5\%$ or 0.5 pF whichever is greater X7R: $ \Delta C/C $: $\leq 10\%$ D.F.: within initial specified value R_{ins} : within initial specified value
Solderability		4.10	Unmounted chips completely immersed in a solder bath at 235 \pm 5 °C Dipping time: 2 \pm 0.5 seconds Depth of immersion: 10 mm	The termination shall be well tinned.
Rapid change of temperature	4.11		Preconditioning; 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature	No visual damage NP0: IΔC/Cl: ≤ 1% or 1 pF whichever is greater
			5 cycles with following detail: 30 minutes at lower category temperature; 30 minutes at upper category temperature	X7R: $I\Delta C/CI$: $\leq 15\%$ D.F.: within initial specified value R_{ins} : within initial specified value
			Recovery time 24 ±2 hours.	113
Damp heat, with U _r load		4.13	Initial measurements; after $150 \pm 0/-10$ °C for 1 hour, then keep for 24 ± 1 hours at room temperature Duration and conditions: 500 ± 12 hours at 40 ± 2 °C; 90 to 95% RH; U _r applied Final measurement: perform a heat treatment at $150 \pm 0/-10$ °C for 1 hour, final measurements shall be carried out 24 ± 1 hours after recovery at room temperature without load.	NP0: $ \Delta C/C $: $\leq 2\%$ or $ PF $ whichever is greater X7R: $ \Delta C/C $: $\leq 15\%$ NP0: D.F.: $2 \times initial$ value max. X7R $\geq 100 \text{ V}$: D.F. $\leq 5\%$ NP0: $R_{ins} \geq 2,500 \text{ M}\Omega$ or $R_{ins} \times C_r \geq 25$ seconds, whichever is less X7R: $R_{ins} \geq 500 \text{ M}\Omega$ or $R_{ins} \times C_r \geq 25$ seconds, whichever is less



YAGEO Phicomp Surface-Mount Ceramic Multilayer Capacitors | Safety Certification | NP0/X7R | X1/Y2 & X2/Y3

Table 7	Test condition,	procedure and	requirements	(continued)
IUDIC /	i Cot Condition,	procedure and	requirements	(COITHII IUCU)

TEST	TEST METI	HOD	PROCEDURE	REQUIREMENTS
Endurance	EN132400	4.14 SC	Perform shear test, substrate bending test, impulse voltage and then endurance test progressively.	Visual examination
			Same as the above except for 1.25 UR for X-capacitor and 1.7 UR for Y-capacitor.	DC/C < ± 20%
			Once every hour the voltage shall be increased to I000VAC for 0.1 s.	Voltage proof
			Total time take to change over to 1000 VAC and back does not exceed 30 s.	IR > 3×10E9 Ω
Impulse Voltage		4.13 SC	XI: 4.0k VDC, X2: 2.5k VDC, X3: I.2k VDC YI: 8.0k VDC, Y2: 5.0k VDC, Y3: None, Y4: 2.5k VDC	No breakdown or flashover
			Apply 3 successive impulses. Time between impulses shall not be less than 10 s.	
Robustness of Termination (Pull Strength)		4.3 SC	a. A force applied for 10 sec to the line joining the terminations and in a plane parallel to the substrate.	a. No visible damage
			b. A force applied until broken	b. Force size≥ 0603: ≥ 5N size = 0402: ≥ 2.5N size = 0201: ≥ 1N
Voltage proof		4.2.1 SC	For X1, X2 and X3: 4.3Ur (1.075k VDC) For Y1: 4k VAC For Y2 and Y3: 1.5k VAC For Y4: 900 VAC	No breakdown or flashover